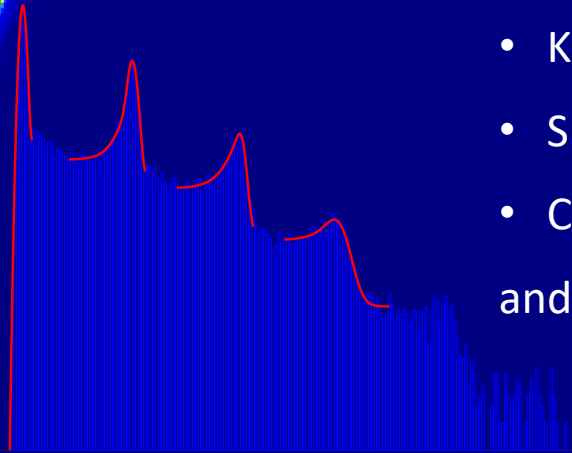
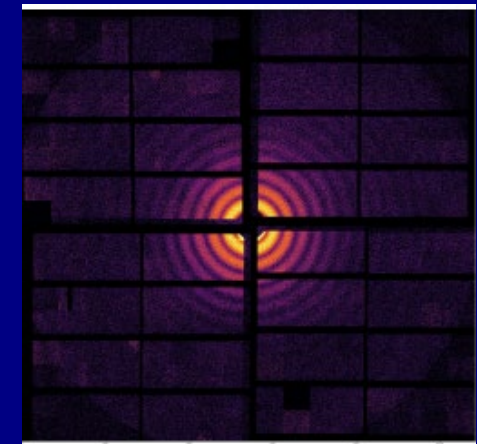




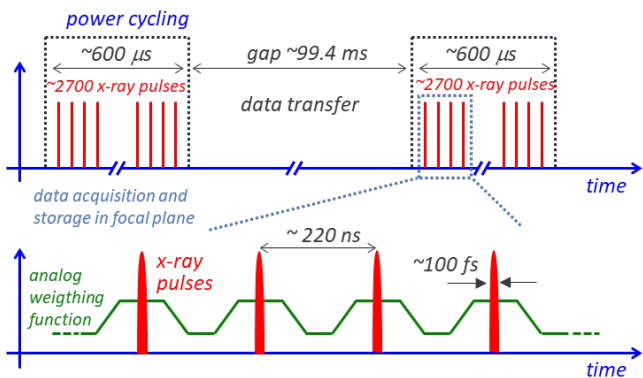
Calibration and Performance of the First Depfet Ladder of the DSSC X-ray Imager

- A. Castoldi, M. Ghisetti, C. Guazzoni, Politecnico di Milano & INFN
- K. Hansen, S. Maffessanti, DESY
- S. Aschauer, L. Strüder, PNSensor GmbH
- C. Danilevski, M. Turcato, M. Porro, European XFEL GmbH
and the DSSC Consortium



□ Main features

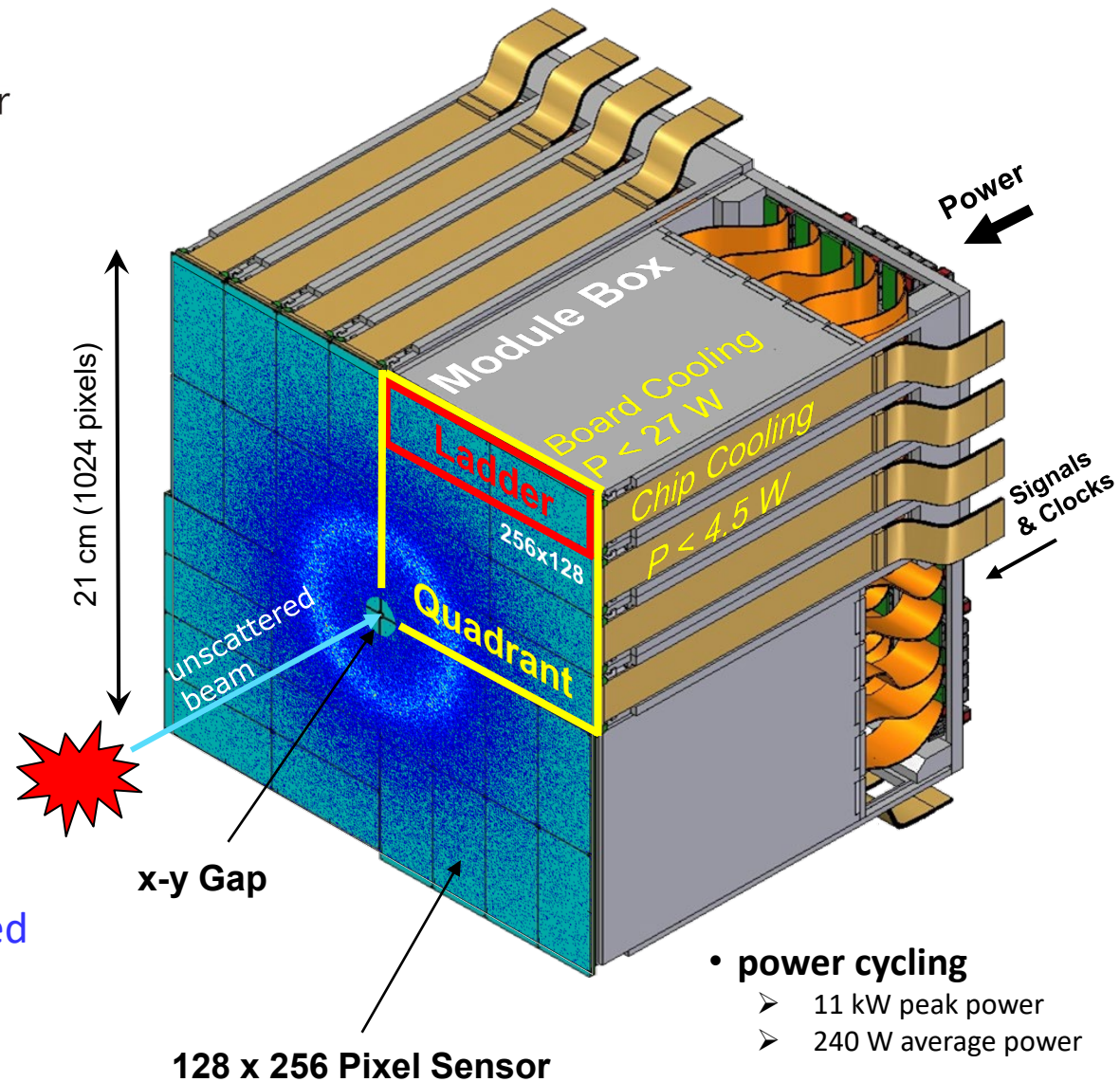
- based on **non-linear DEPFET** sensors
- $\sim 200 \mu\text{m}$ hex pixel (1024 x 1024)
- **photon energy 0.5 - 6 keV**
- **single-photon sensitivity**
- **dynamic range 1:10,000 ph**
- **frame rate 0.9 – 4.5 MHz**



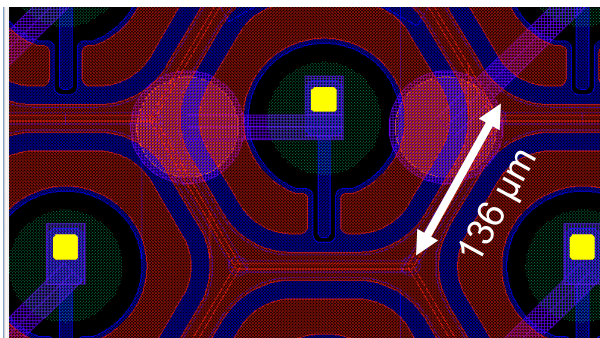
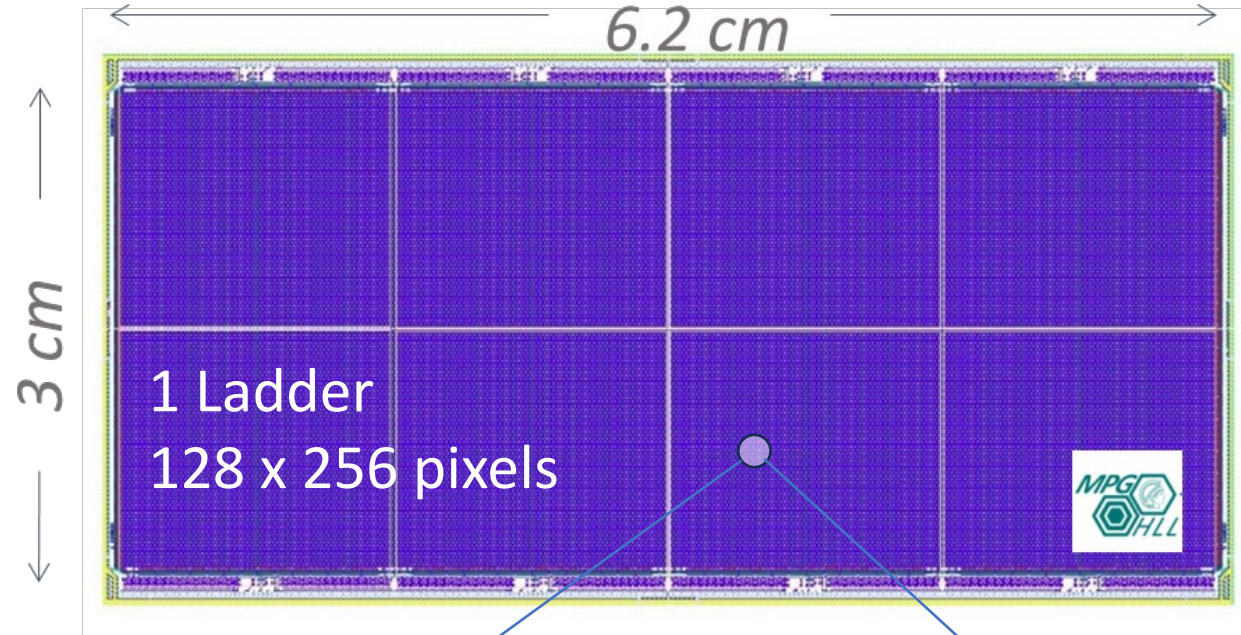
4.5 MHz operation (burst mode) at the European XFEL

↳ accurate calibration of multiple DSSC properties is needed (gain, offset, noise, QE, charge-sharing, etc)

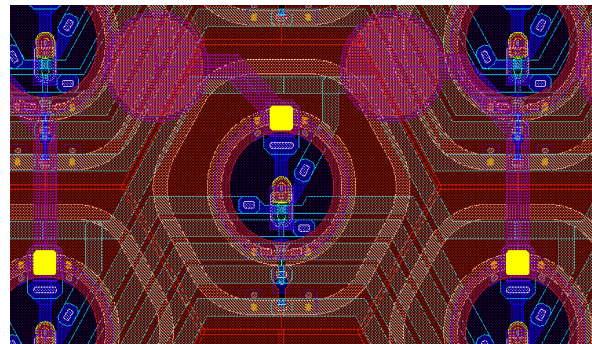
↳ performance qualification of the 1st DEPFET ladder



- **power cycling**
 - 11 kW peak power
 - 240 W average power

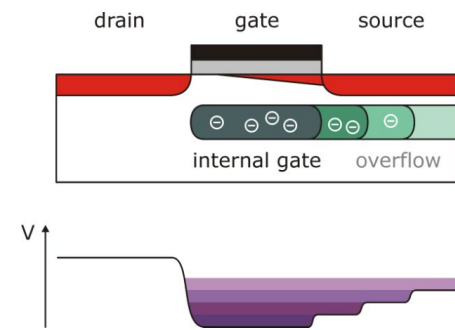


MiniSDD
Passive anode
450 μm thickness

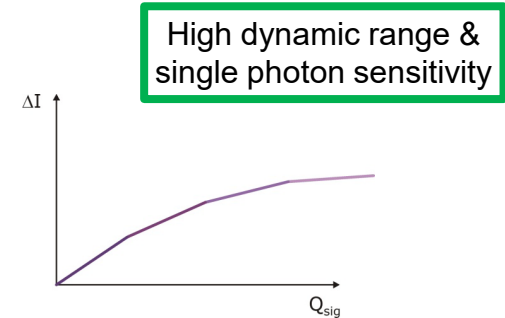


CMOS-DEPFET Active Pixel
(IMS, PNSensors)
8" Si wafer 750 μm thickness

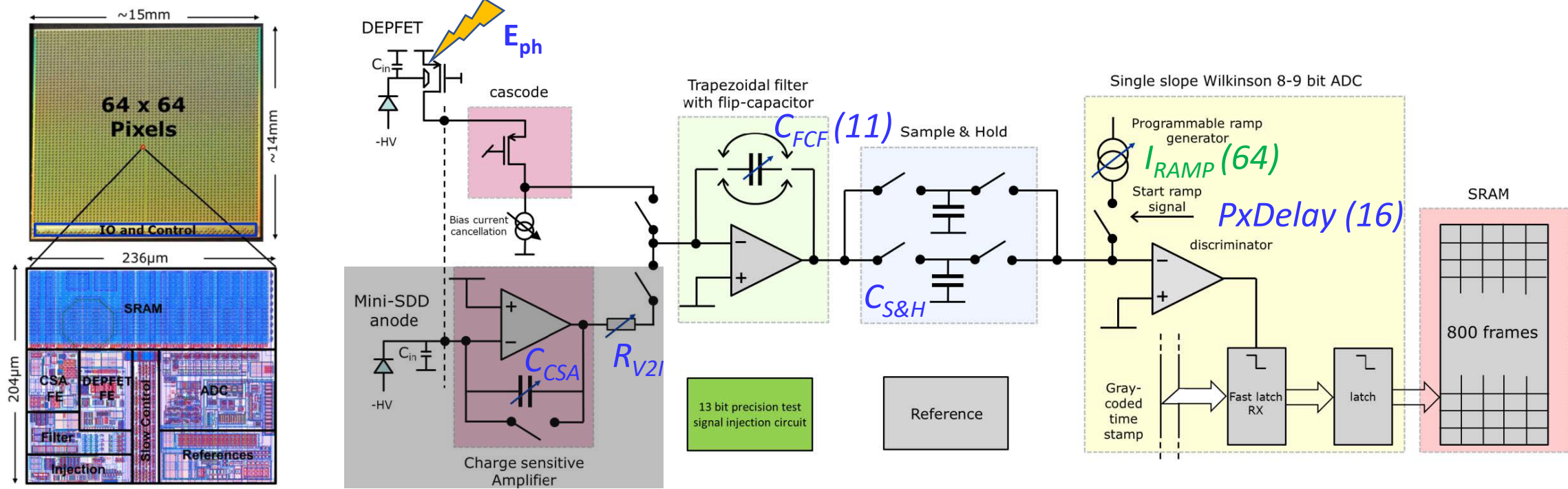
- Passive anode („mini“-SDD) (1 Mpix delivered in 2019)
- DSSC adaptation of the DEPFET concept:
 - ↳ internal gate extends under the source
 - ↳ at high levels, signal charges gradually spread under source
 - ↳ **non-linear $\Delta I/Q_{sig}$ curve**
 - ↳ gain curve engineering by dose & geometry of implantations



CMOS-foundry DEPFET technology
(PNSensor GmbH)
S. Aschauer, et al. JINST (2017)



- Low noise
- Fast collection
- Signal compression



Readout concept

- Full-parallel readout
- Analog shaping
- In-pixel 8-bit digitization (9-bit @ $f < 4.5\text{MHz}$)
- In-pixel SRAM (800 frames/burst)
- Data transmission during gaps

↳ limited ADC resolution

Gain and offset adjustable pixel-wise

- 11 settings of C_{fc} (coarse gain) for photon energy/dyn. range selection
- 6 bits of ADC gain fine trimming (nominal accuracy $\sim 1\%$)
- 4 bits for offset trimming (1.5 LSB range with 8% granularity)

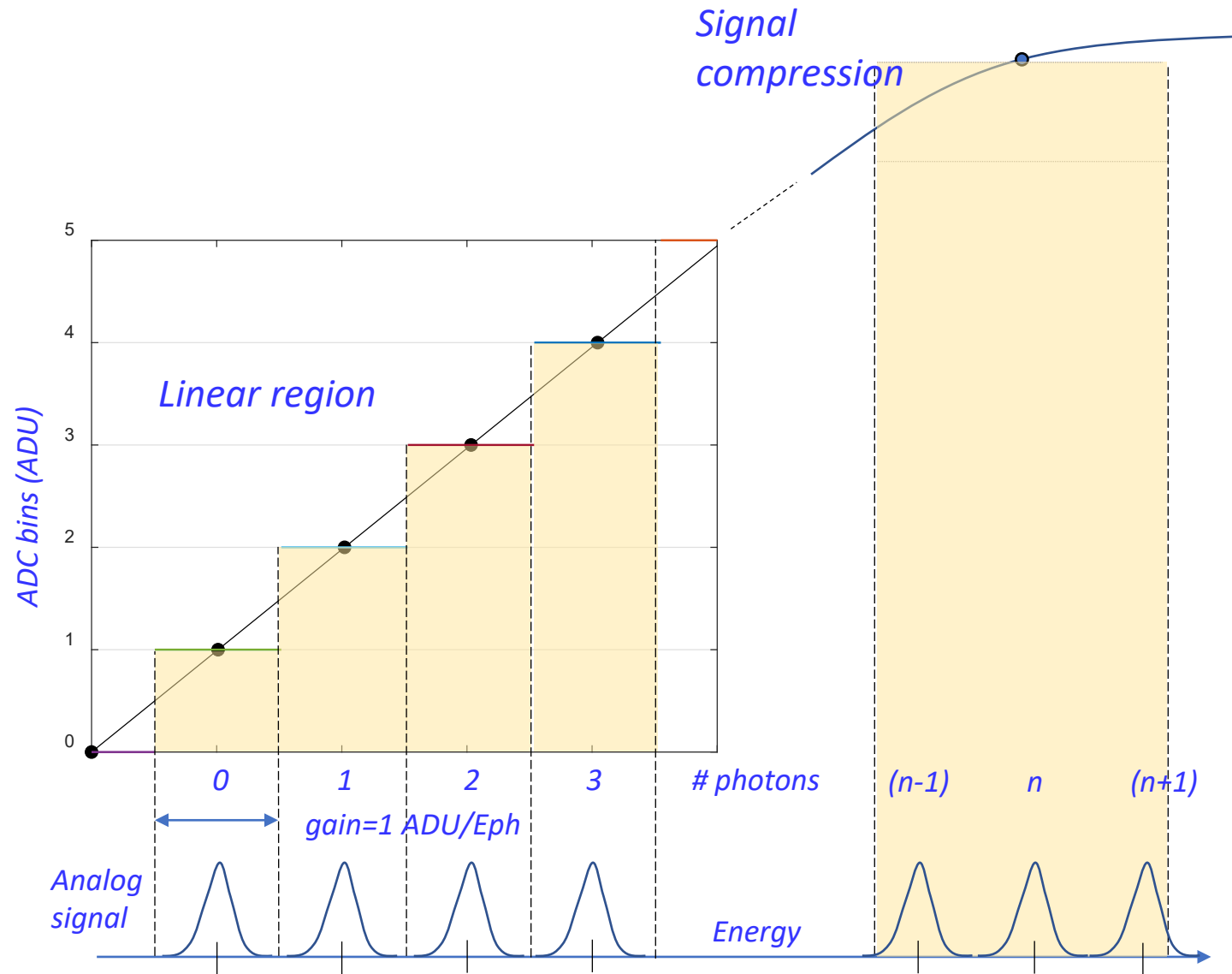
$$\text{Gain} \propto g_Q \frac{1}{C_{FCF}} \frac{1}{I_{RAMP}} (t_{INT} \cdot C_{S\&H}) (2 \cdot f_{clock})$$

↳ fine gain/offset trimming @ pixel level

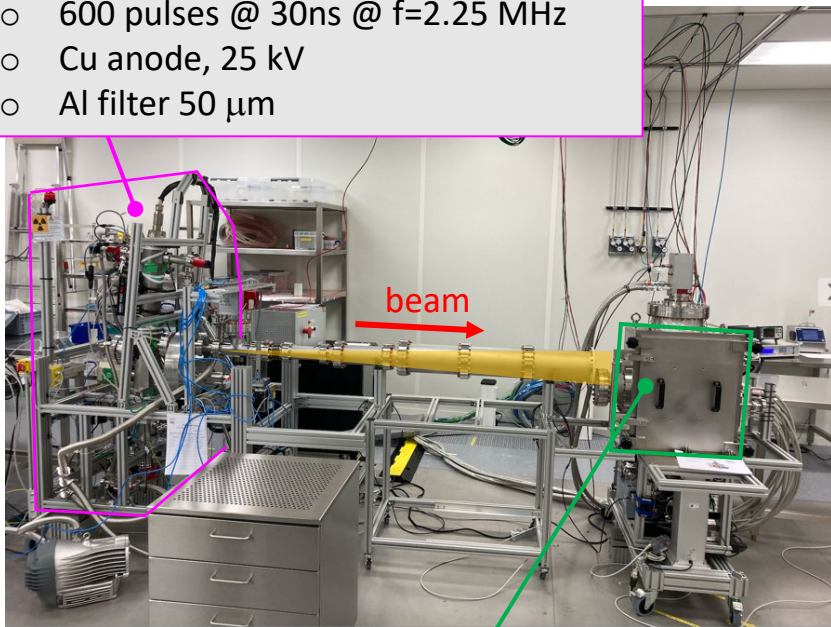
- Under the constraints of maximum **dynamic range** and **8-bit resolution**, single-photon counting is possible by setting **DEPFET signal for 1 photon** equal to **1 (or n) ADC bin**
 - signal compression will extend the DR

- **Gain and offset** in the read-out ASIC **must be set** for the chosen photon energy ***a priori***, before the experiment is performed
 - difficult to re-gain single-photon counting by a re-calibration of the data

- inevitable **process variations** in the sensor as well as in the read-out ASIC
 - **each DSSC pixel** must be **calibrated individually** (~1% accuracy)

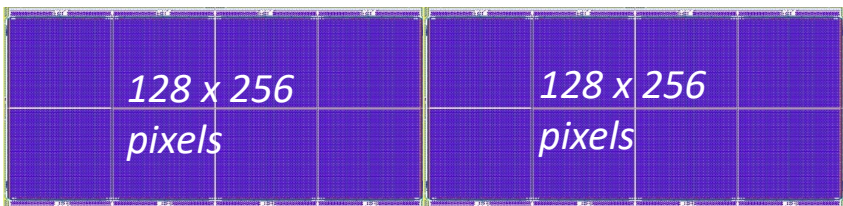


- PulXar source @XFEL DET Group
- 600 pulses @ 30ns @ f=2.25 MHz
- Cu anode, 25 kV
- Al filter 50 μ m

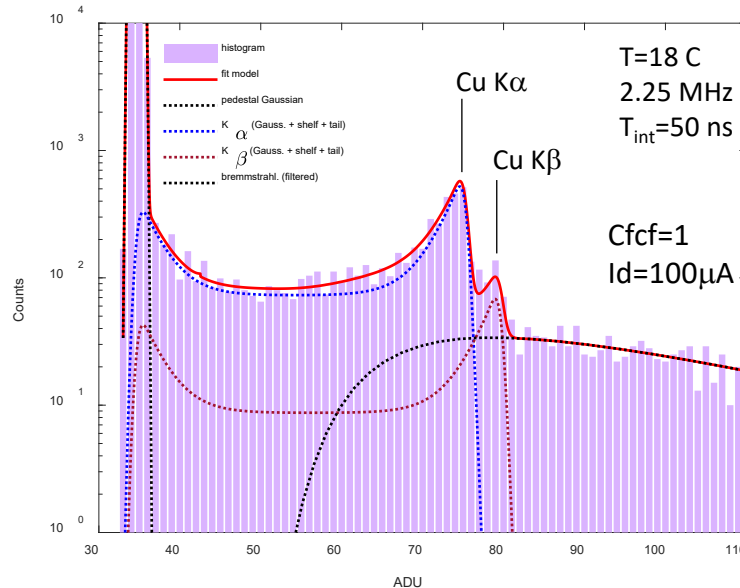


FENICE vessel/DEPFET ladder

- DEPFET ladder (128 x 512)

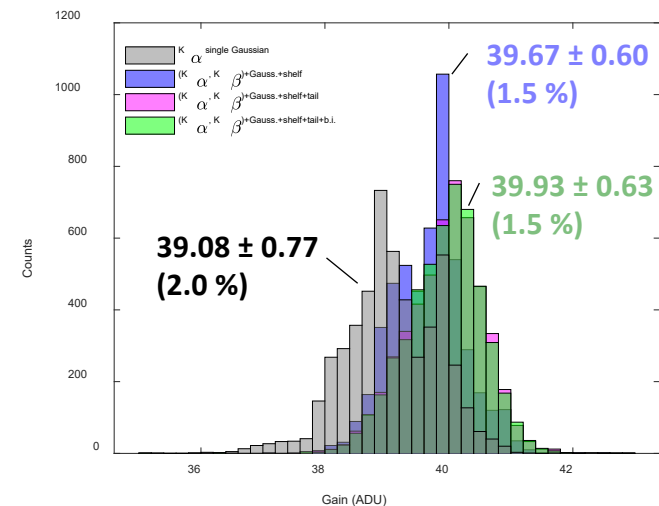
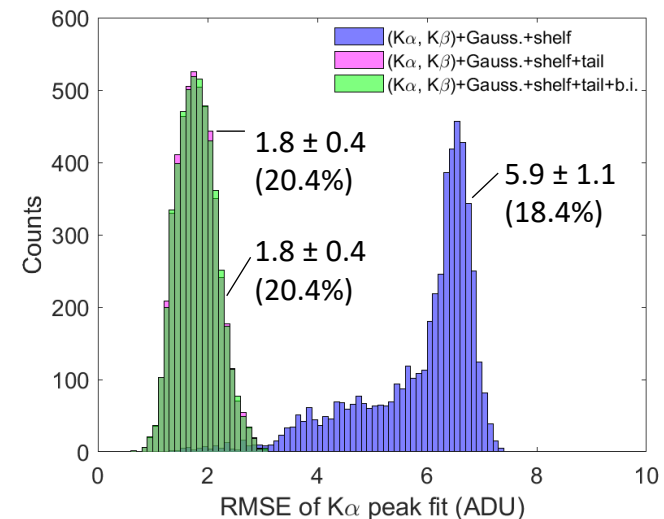


X-ray spectra fitting @ high gain

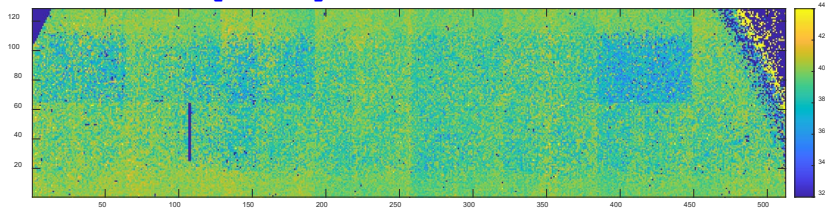


- low ADC resolution impacts on accuracy of gain/offset determination
- characterization/modeling of DEPFET spectral response (14-bit test bench)
 - charge-sharing (i.e. low-energy tail)
 - bremsstrahlung
 - bin integration

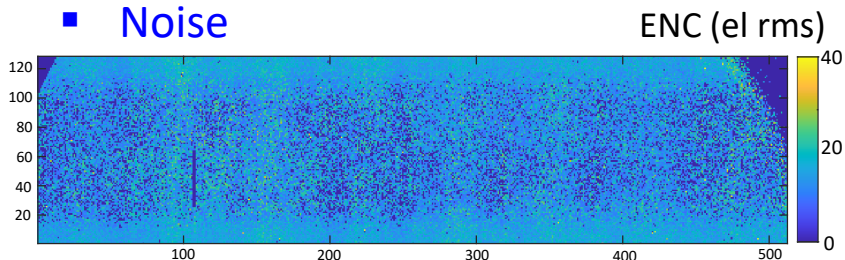
“Trimming” X-ray spectra fit models



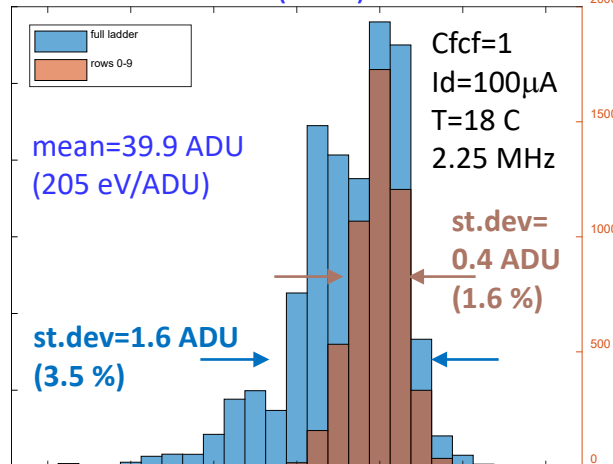
Gain [ADU]



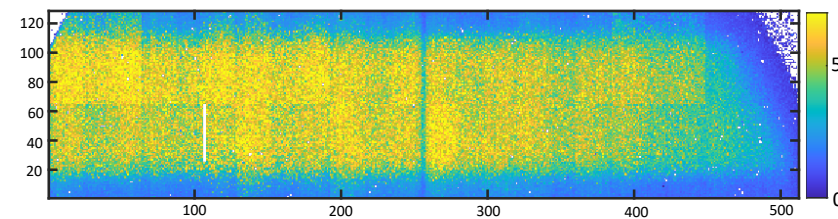
Noise



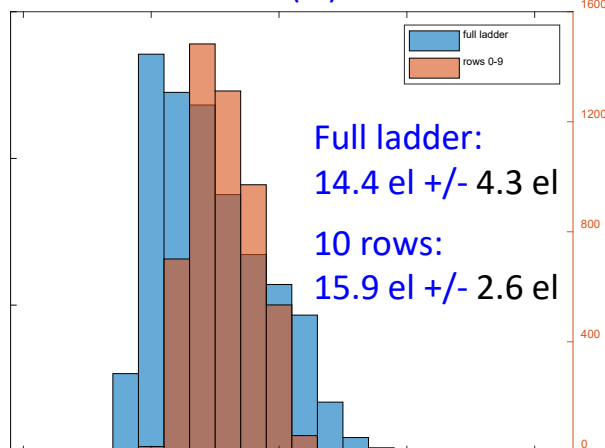
Gain (ADU)



Cu $K\alpha$ fit RMSE [ADU]



ENC (el)



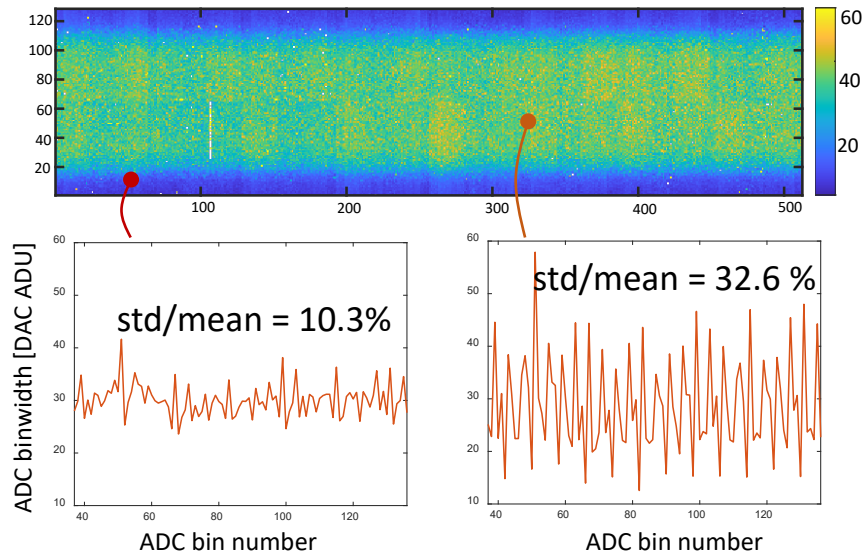
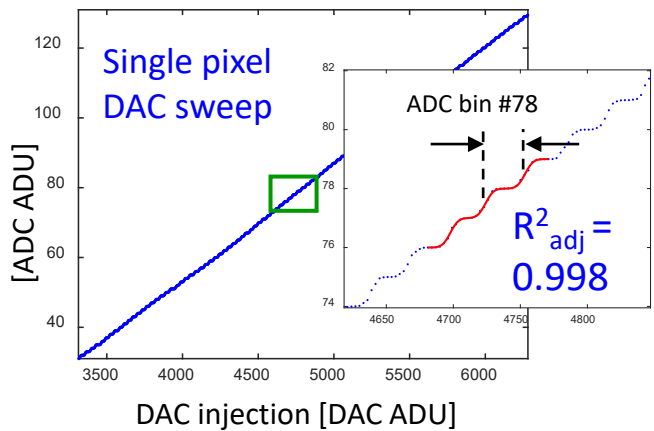
Gain

- small spread across ladder (gain untrimmed)
- “10-row” spatial pattern ?
→ related to ADC non linearity

Noise (@ T=18 C)

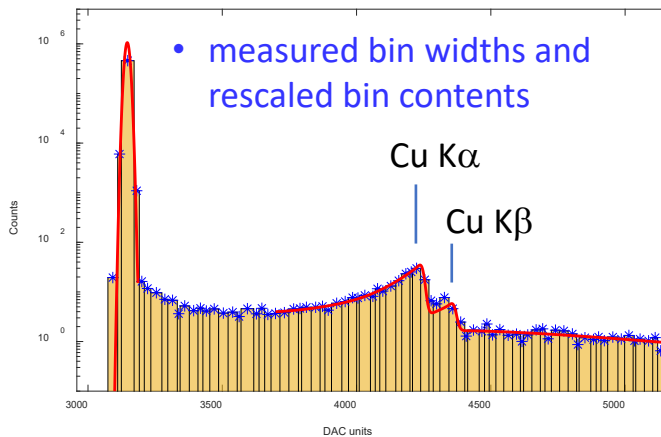
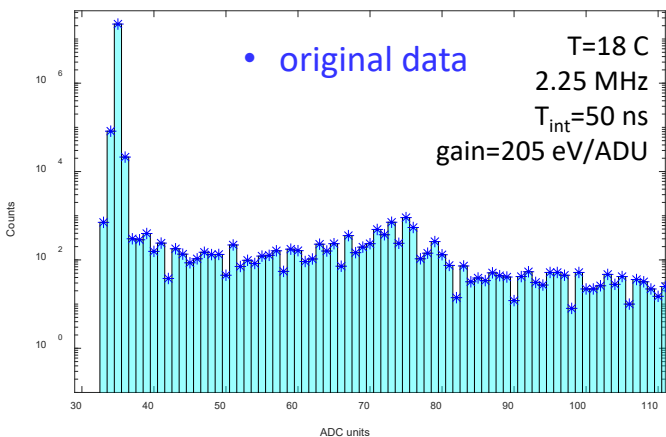
- ENC 16 el rms @2.25 MHz

Measured ADC differential non-linearity (DNL) %

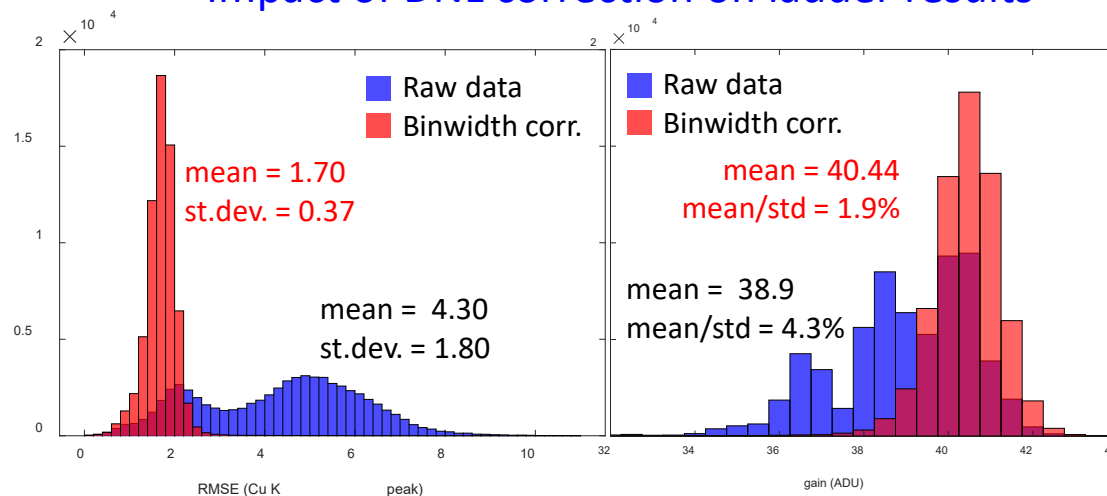


- ADC “staircase” measured on all pixels with 13-bit DAC
- Use of measured ADC binwidths shows clear improvement of all GOF indicators in peak fitting/spectral performance
 - gain accuracy $\sim 1\%$ over all ladder
- Automatic procedure, can be extended at camera level

PulXar Cu Ka spectra/gain calibration



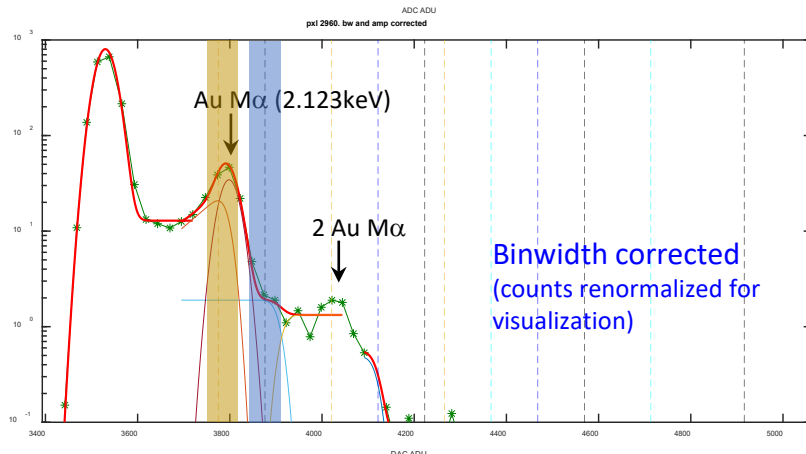
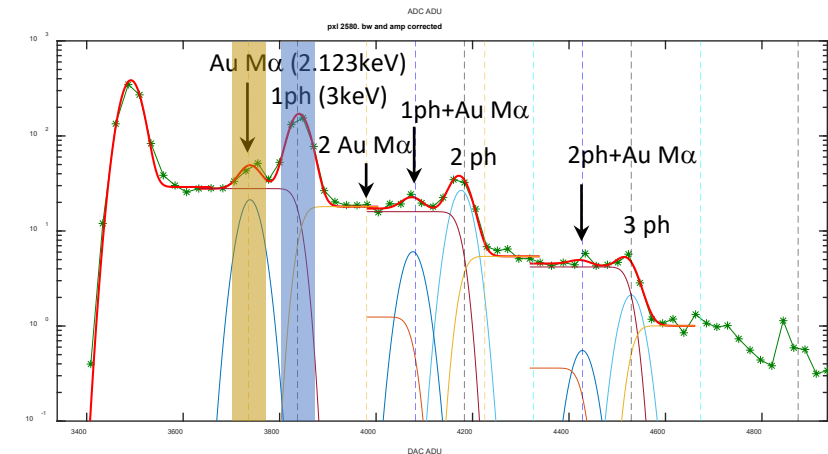
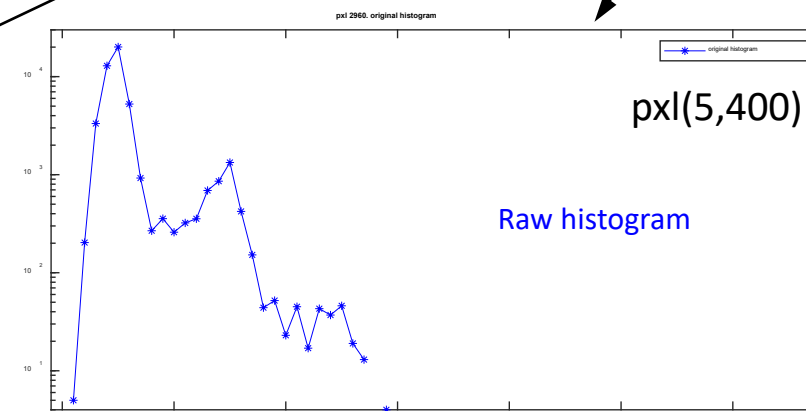
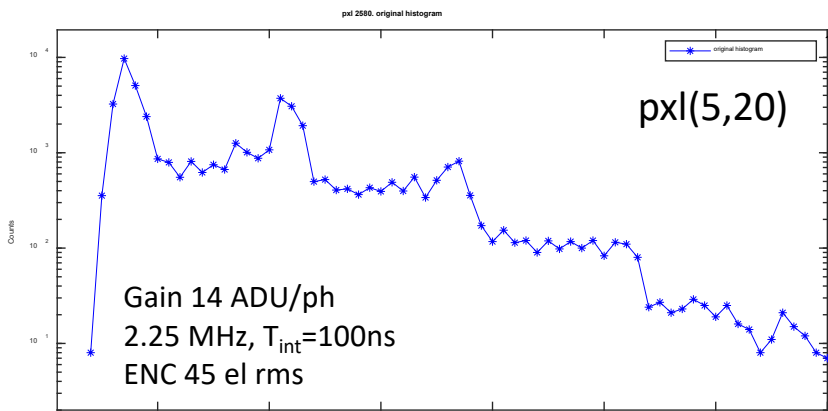
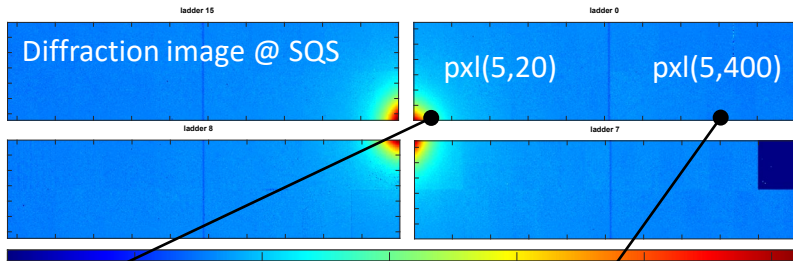
Impact of DNL correction on ladder results



- Diffraction mask (pinhole array)

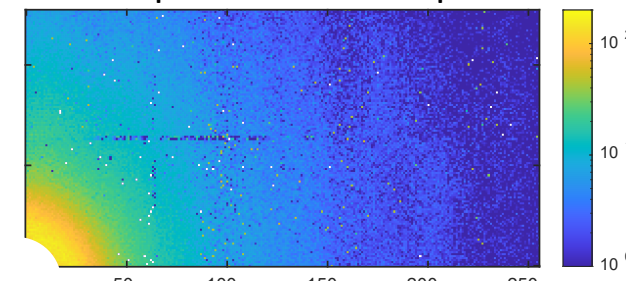
- 30nm SiN
- 5 nm Cr/250nm Au coating

- Pixel spectra vs. primary/XRF intensity

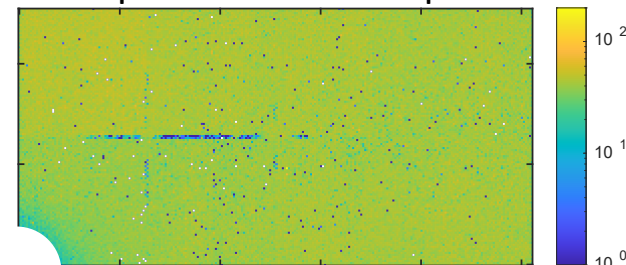


- ADC binwidth measured on 1 Mpix MiniSDD camera
- Preliminary extraction of «2-color» maps (3 keV and Au Mα 2.123 keV)

Amplitude of 3 keV peak



Amplitude of Au Mα peak



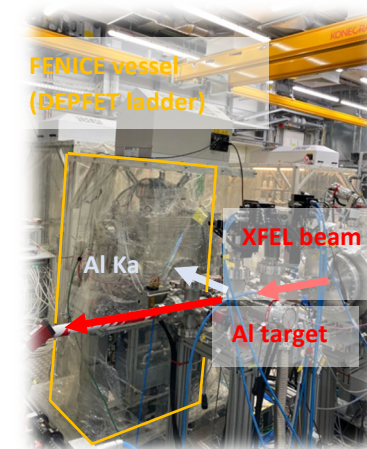
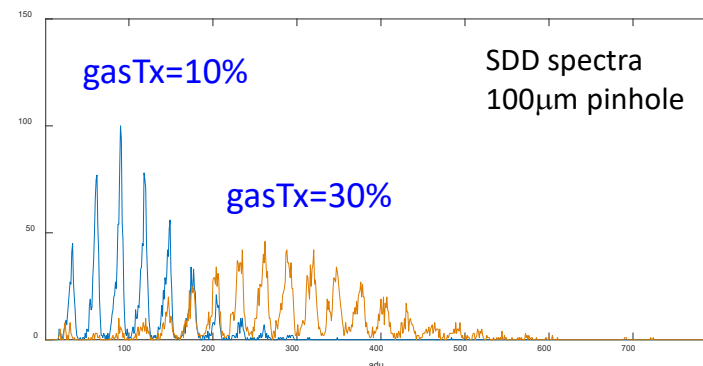
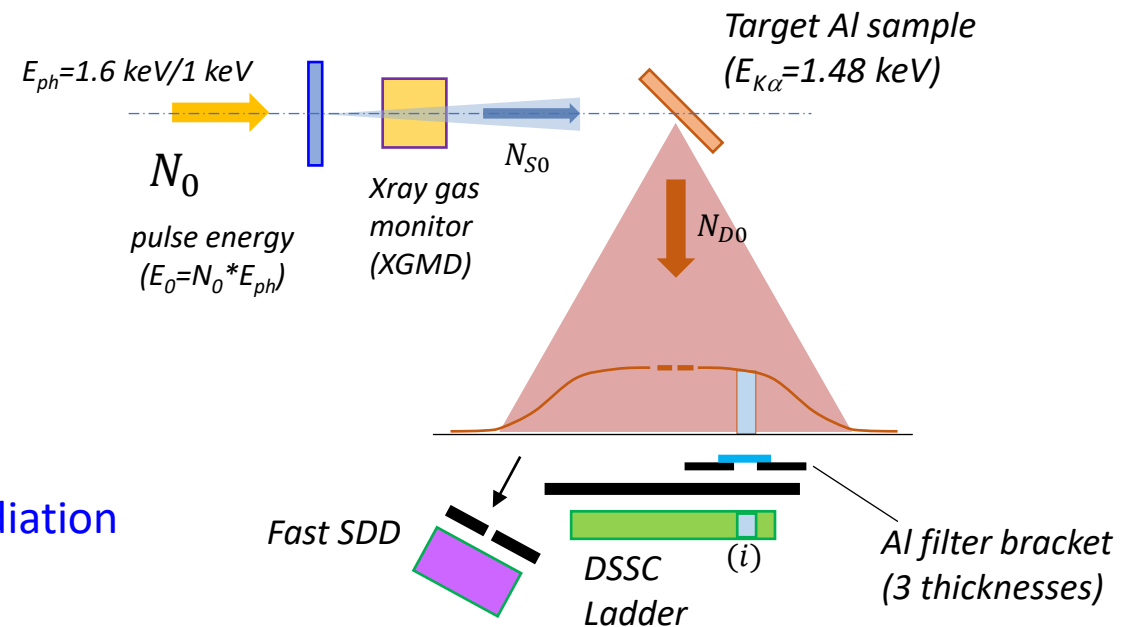
- ADC binwidths (meas. 2024) successfully applied to detector data nearly 3 years older (2021)

- Dedicated beamtime at XFEL:
 - spectroscopic performance
 - qualification of the non-linear DEPFET response

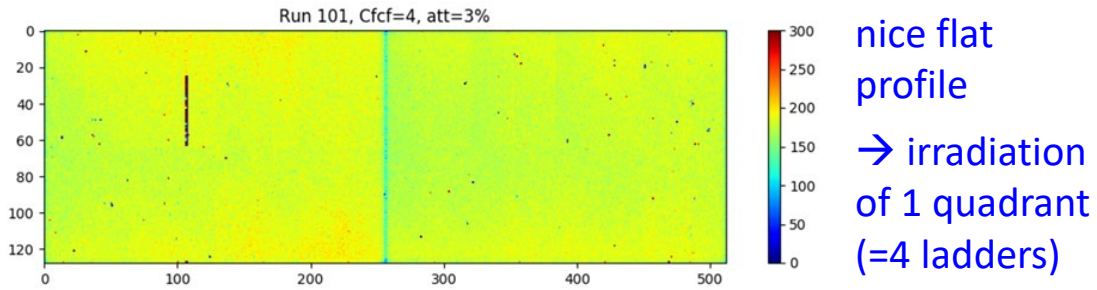
- Setup @ SQS beamline
 - XFEL beam on Al target
 - DEPFET ladder perpendicular to the beam → uniform irradiation

- NL response
 - to scan the NL curve we change beam attenuation
 - 3 different intensity monitors (SDD, DEPFET + Al filters, X-ray gas detector)

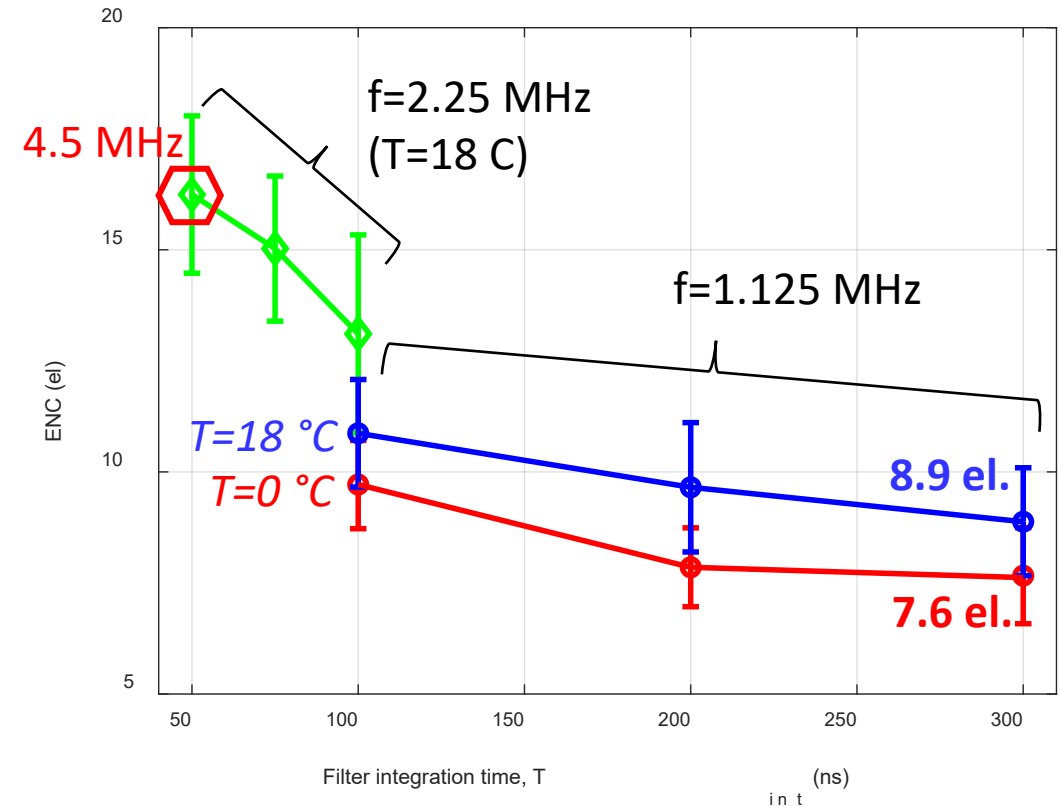
setup @ SQS beamline



- irradiation profile of Al Ka photons



- ENC: dependence on integration time



1.125 MHz ($T_{int}=300$ ns, $T=0$ C)
ENC=7.6 ± 1.1 el.

1.125 MHz ($T_{int}=300$ ns, $T=18$ C)
ENC=8.9 ± 1.2 el.

2.25 MHz ($T_{int}=100$ ns, $T=18$ C)
ENC=13.1 ± 2.2 el.

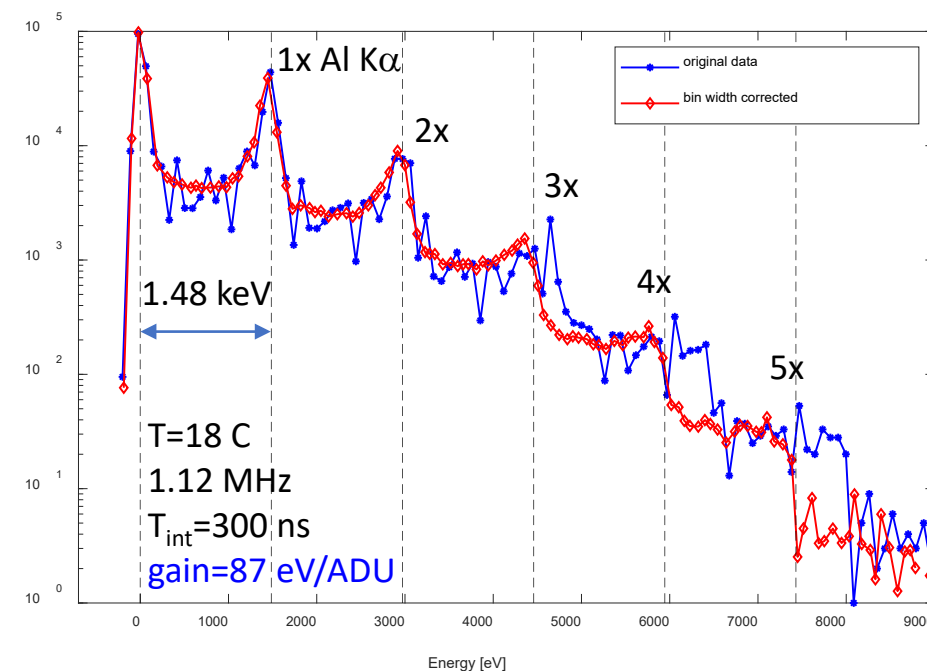
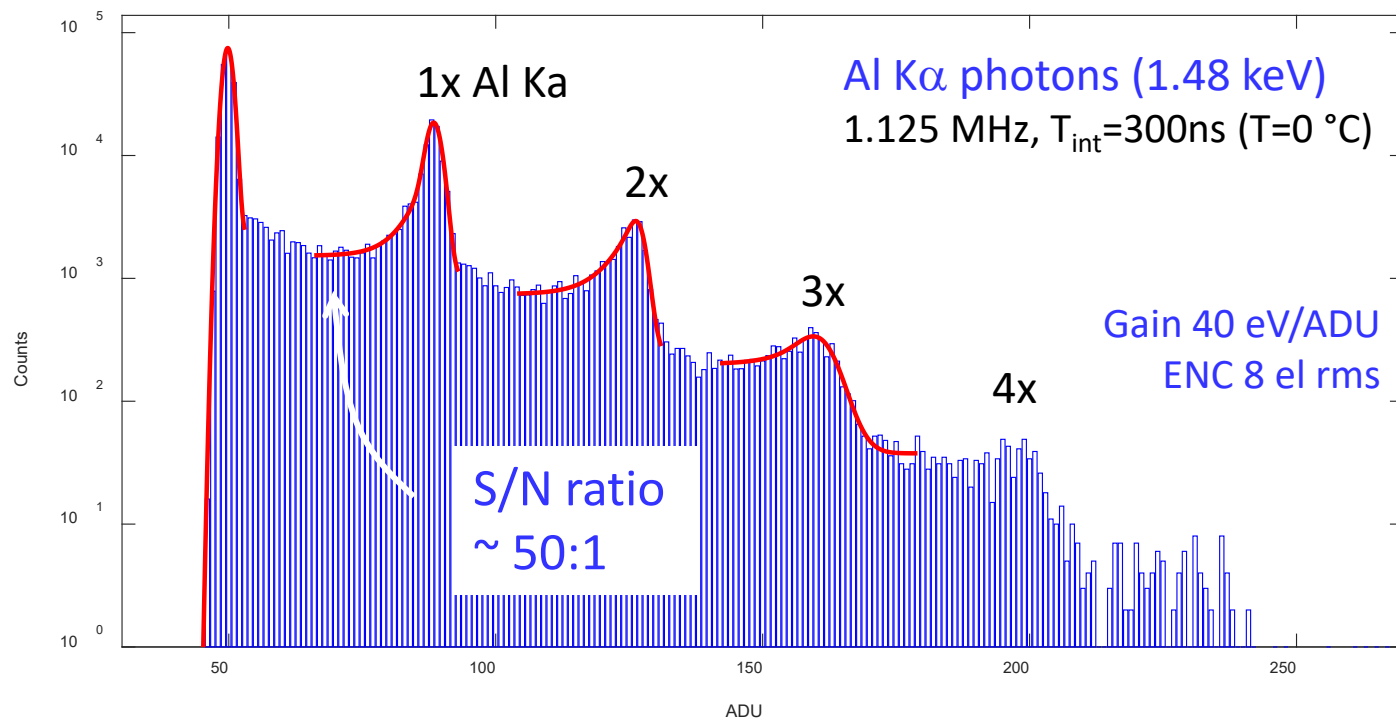
2.25 MHz ($T_{int}=50$ ns, $T=18$ C)
ENC=16.2 ± 1.8 el.

ENC:
selected
histograms

5120 entries

- ENC ~ 16 el @ $T_{int}=50$ ns, compatible with PulXar results ($f=4.5$ MHz operation)
- ENC improves with int. time: ENC < 10 el rms @ $T_{int} > 100$ ns

- SQS beamline / Al target



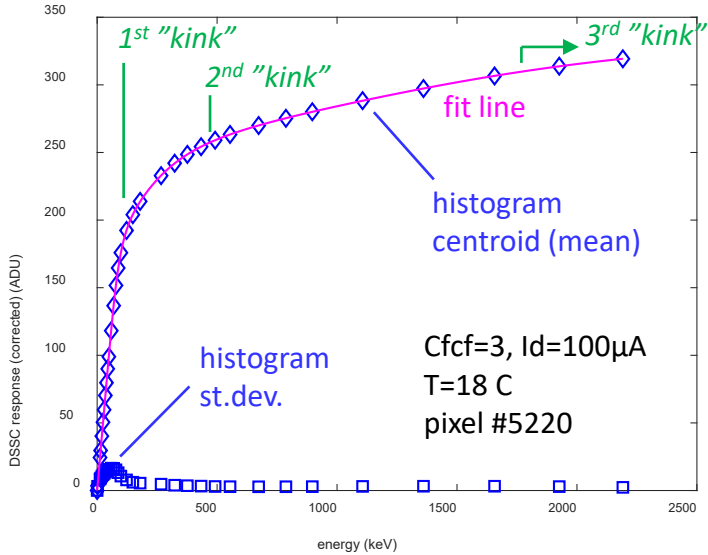
- high gain mode tested (40 eV/ADU), **single-photon resolution** of Al Kα photon peaks with **S/N~50:1**
- multi-peak spectrum shows INL errors, effectively improved by binwidth correction (INL $\sim 10^{-3}$ ph)
 - better spectroscopic discrimination for soft X-rays

Intensity "scans"

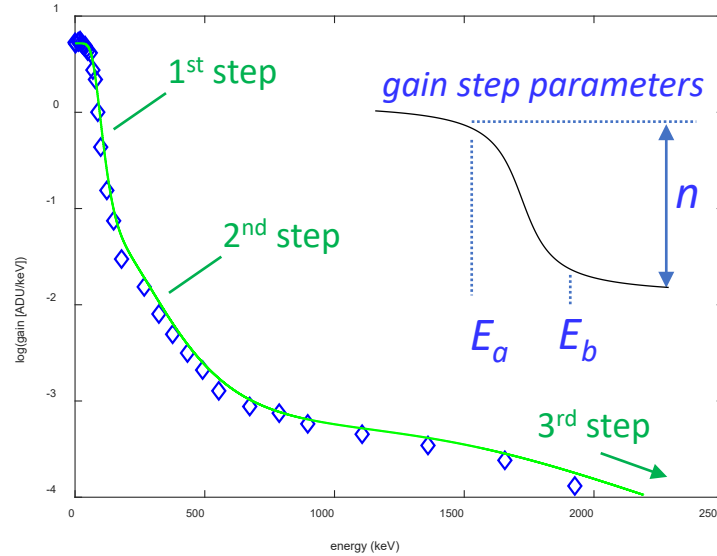
- acquisition of flat-field images of Al Ka photons vs. gasTx
- successful qualification of the whole compression curve

Single pixel NL response curve / gain vs. deposited energy

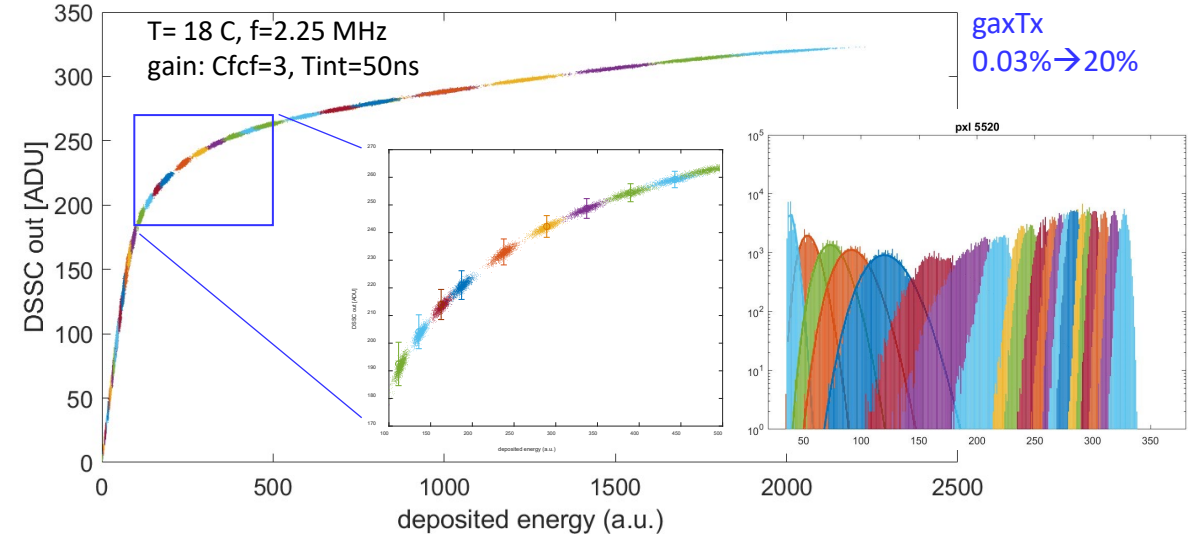
DEPFET response curve



DEPFET gain

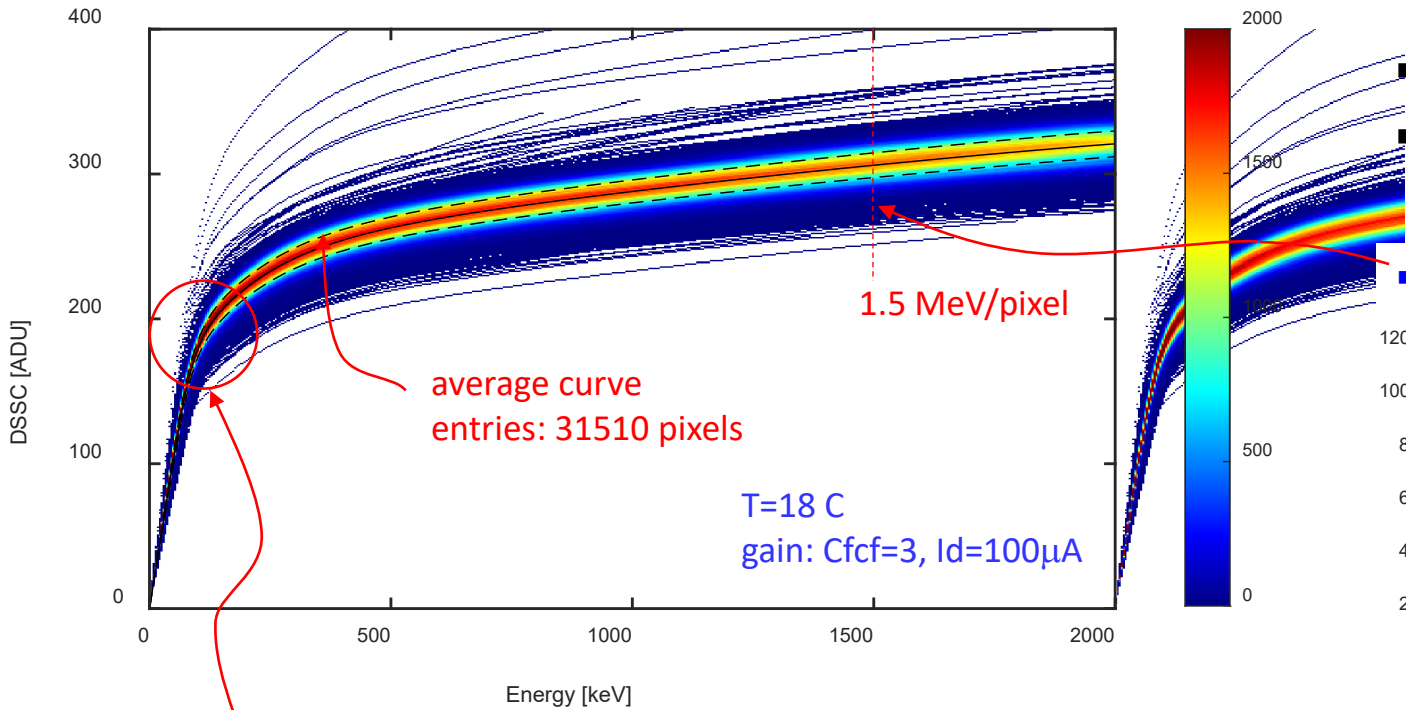


Raw data of a single pixel (train data)



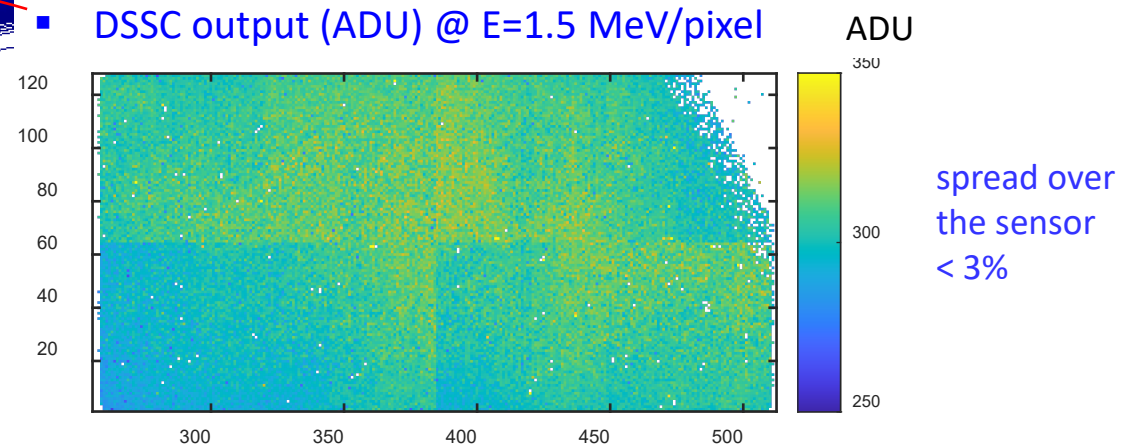
- maximum tested energy about 2 MeV (~1400 Al Ka/pixel)
- Custom fit model (3 fit var/kink)

■ NL response curves (right sensor) – persistence plot

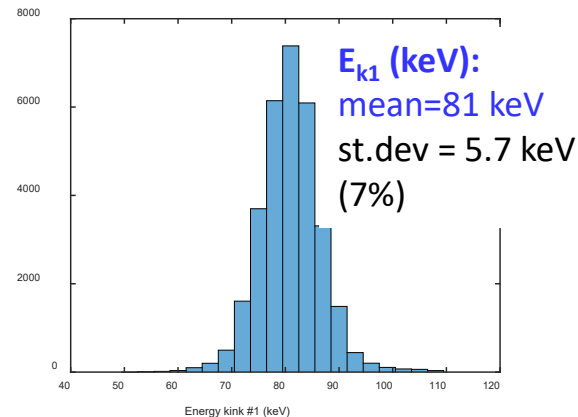
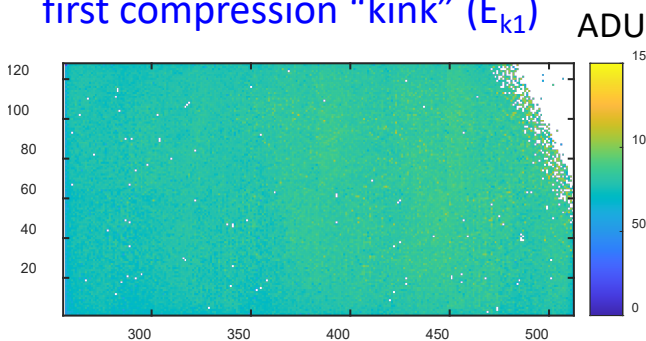


data analysis/calibration over all pixels
non-linear fit function, 9 fit parameters/pixel

■ DSSC output (ADU) @ E=1.5 MeV/pixel

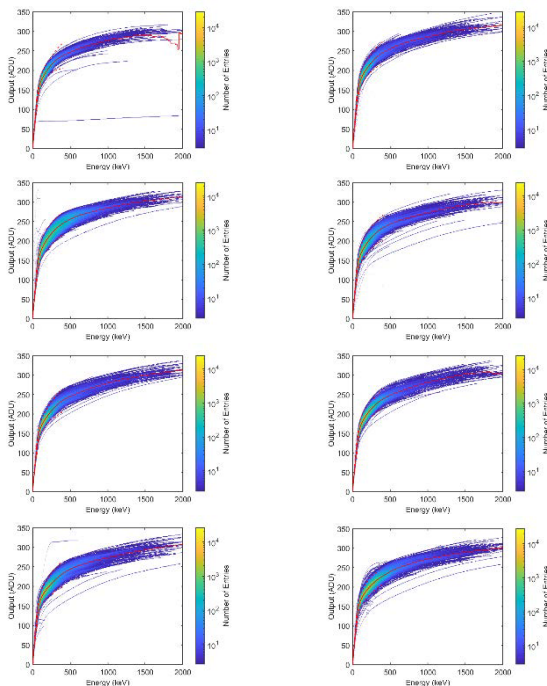
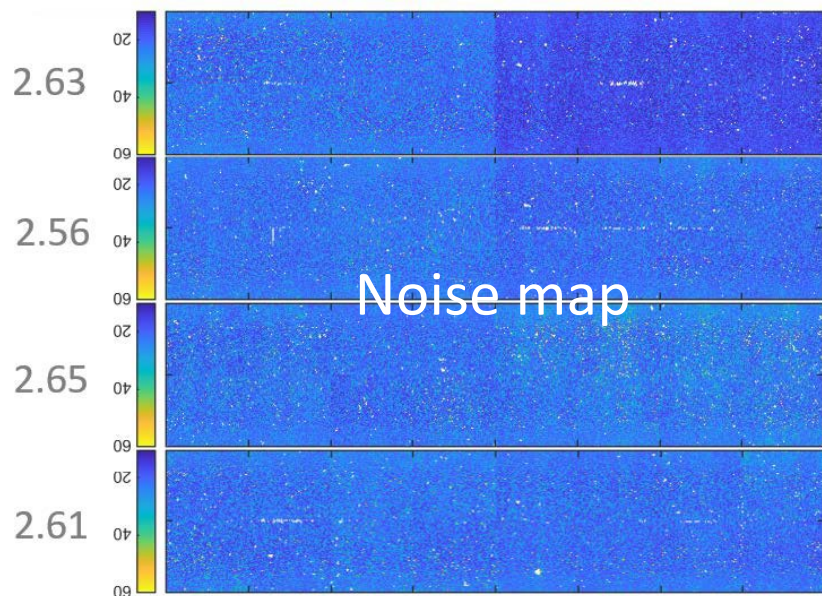


■ first compression “kink” (E_{k1})



- first energy kink at ~81 keV with small spread (~7%) over the sensor
- at high intensity, very nice uniformity (< 3%)

- Functional tests at Quadrant level



- After quality control on submodules, 3 quadrants of the DEPFET camera have been assembled
- An additional DEPFET production is ongoing in order to complete the camera and provide spare parts
- First user experiments scheduled for the first half of 2025

- single-photon counting of soft X-rays & high dynamic range with limited ADC resolution turned to be a significant challenge for calibration of the DSSC detector
- experimental qualification of first DEPFET ladder confirmed improvements promised by the novel CMOS-DEPFET technology
 - noise 16 el rms @ T=18C @4.5 MHz, improved to 8 el rms @T=0 °C @1.1 MHz
 - ADC binwidth correction shows decisive improvement of spectroscopic discrimination capability and of calibration data accuracy
- qualification technique of the DEPFET NL response @ SQS beamline validated
 - quadrant-size illumination, accurate calibration of the deposited energy, dynamic range of several 1000s photons @ 1 keV
 - *potential of the DEPFET-based pixel to reach **single-photon imaging down to the lowest photon energy (0.5 keV or lower) combined with high dynamic range at camera level***
- outlook
 - qualification of the response at soft X-ray energies (< 1keV). Beam time @ XFEL SCS foreseen in Q3 2024
 - Calibration of the assembled 1 Mpix DEPFET camera

Thank you for your attention !

